

Chapter 1 Basics

Overview The focus of this chapter is on the introduction of the VIPA System 200V. Various options of configuring central and decentral systems are presented in a summary.

 The chapter also contains the general specifications of the System 200V, i.e. dimensions, installation and environmental conditions.

- Below follows a description of:
- Introduction of the System 200V
 - General information, i.e. installation, operational safety and environmental conditions

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Safety information for Users

Handling of electrostatically sensitive modules

VIPA modules make use of highly integrated components in MOS-technology. These components are extremely sensitive to over-voltages that can occur during electrostatic discharges.

The following symbol is attached to modules that can be destroyed by electrostatic discharges:



The symbol is located on the module, the module rack or on packing material and it indicates the presence of electrostatic sensitive equipment.

It is possible that electrostatic sensitive equipment is destroyed by energies and voltages that are far less than the human threshold of perception. These voltages can occur where persons do not discharge themselves before handling electrostatically sensitive modules and they can damage components thereby, causing the module to become inoperable or unusable. Modules that have been damaged by electrostatic discharges may fail after a temperature change, mechanical shock or changes in the electrical load.

Only the consequent implementation of protection devices and meticulous attention to the applicable rules and regulations for handling the respective equipment can prevent failures of electrostatically sensitive modules.

Shipping of electrostatically sensitive modules

Modules have to be shipped in the original packing material.

Measurements and alterations on electrostatically sensitive modules

When you are conducting measurements on electrostatically sensitive modules you should take the following precautions:

- Floating instruments must be discharged before use.
- Instruments must be grounded.

Modifying electrostatically sensitive modules you should only use soldering irons with grounded tips.



Attention!

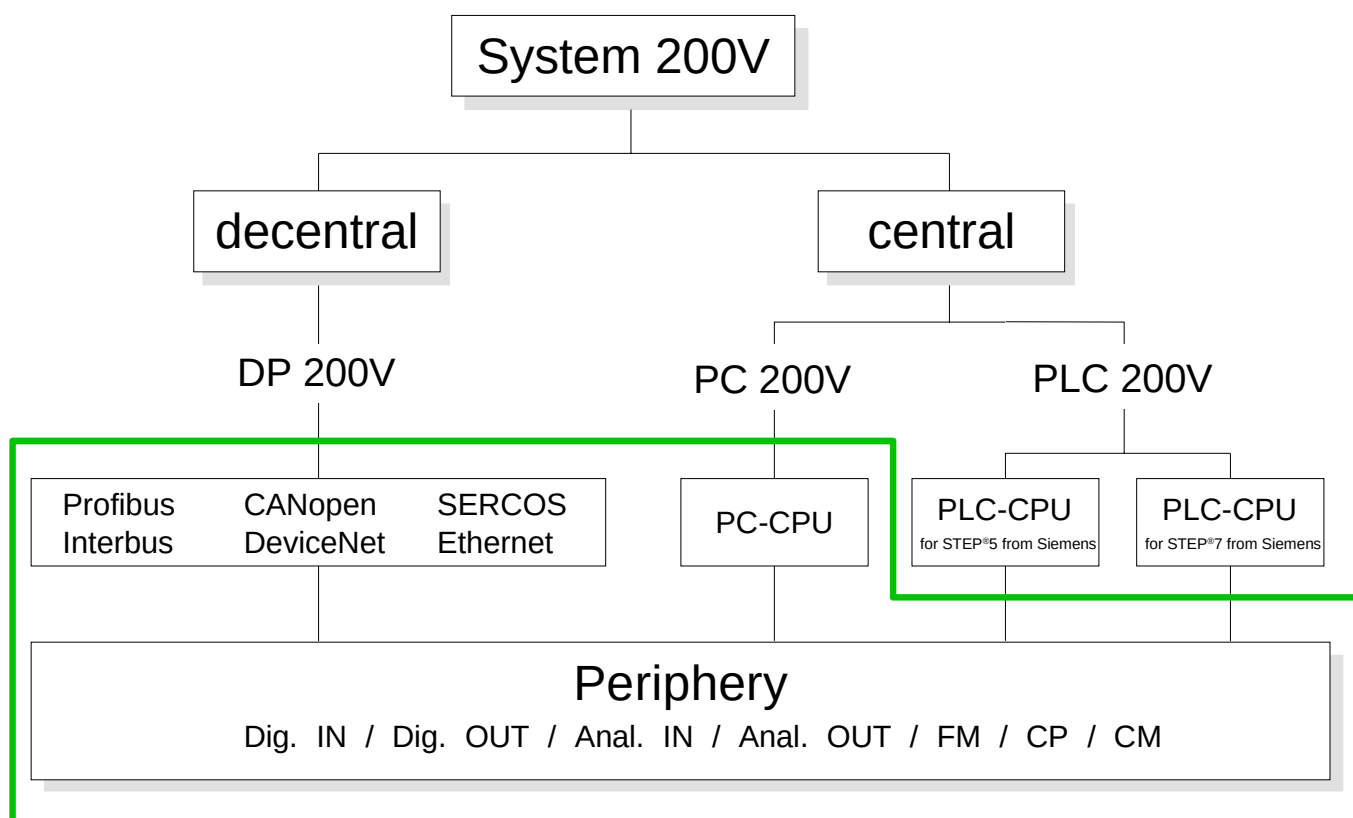
Personnel and instruments should be grounded when working on electrostatically sensitive modules.

Overview

The System 200V

The System 200V is a modular automation system for centralized and decentralized applications requiring low to medium performance specifications. The modules are installed directly on a 35mm DIN rail. Bus connectors inserted into the DIN rail provide the interconnecting bus.

The following figure illustrates the capabilities of the System 200V:



Components

Centralized system

The System 200V series consists of a number of PLC-CPU's. These are programmed in STEP[®]5 or STEP[®]7 from Siemens.

CPU's with integrated Ethernet interfaces or additional serial interfaces simplify the integration of the PLC into an existing network or the connection of additional peripheral equipment.

The application program is saved in Flash or an additional plug-in memory module.

The PC based CPU 288 can be used to implement operating/monitoring tasks, control applications or other file processing applications.

The modules are programmed in C++ or Pascal.

The PC 288-CPU provides an active interface to the backplane bus and can therefore be employed as central controller for all peripheral and function modules of the VIPA System 200V.

With the appropriate expansion interface the System 200V can support up to 4 rows.

Decentralized system

In combination with a Profibus DP master and slave the PLC-CPU's or the PC-CPU form the basis for a Profibus-DP network in accordance with DIN 19245-3. The DP network can be configured with WinNCS VIPA configuration tool res. Siemens SIMATIC Manager.

Other fieldbus systems may be connected by means of slaves for Interbus, CANopen, DeviceNet, SERCOS and Ethernet.

Peripheral modules

A large number of peripheral modules are available from VIPA, for example digital as well as analog inputs/outputs, counter functions, displacement sensors, positioners and serial communication modules.

These peripheral modules can be used in centralized as well as decentralized mode.

Integration over GSD File

The functionality of all VIPA system components are available via different GSD-files.

For the Profibus interface is software standardized, we are able to guarantee the full functionality by including a GSD-file using the Siemens SIMATIC Manager.

For every system family there is an own GSD-file. Actual GSD files can be found at ftp.vipa.de/support.

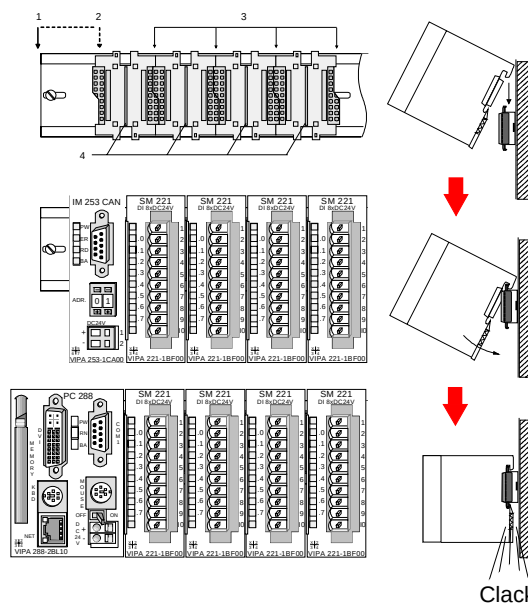
General description System 200V

Structure/ dimensions

- Standard 35mm DIN rail
- Peripheral modules with recessed labelling
- Dimensions of the basic enclosure:
 - 1tier width: (HxWxD) in mm: 76x25.4x74 in inches: 3x1x3
 - 2tier width: (HxWxD) in mm: 76x50.8x74 in inches: 3x2x3

Installation

Please note that you can only install header modules, like the CPU, the PC and couplers into plug-in location 1 or 1 and 2 (for double width modules).



- [1] Header modules, like PC, CPU, bus couplers (double width)
- [2] Header module (single width)
- [3] Peripheral module
- [4] Guide rails

Note

A maximum of 32 modules can be connected at the back plane bus. Take attention that here the **maximum sum current** of **3.5A** is not exceeded.

Please install modules with a high current consumption directly beside the header module.

Reliability

- Wiring by means of spring pressure connections (CageClamps) at the front-facing connector, core cross-section $0.08...2.5\text{mm}^2$ or 1.5 mm^2 (18pole plug)
- Complete isolation of the wiring when modules are exchanged
- Every module is isolated from the backplane bus
- ESD/Burst acc. IEC 61000-4-2 / IEC 61000-4-4 (to level 3)
- Shock resistance acc. IEC 60068-2-6 / IEC 60068-2-27 (1G/12G)

Environmental conditions

- Operating temperature: $0 \dots +60^\circ\text{C}$
- Storage temperature: $-25 \dots +70^\circ\text{C}$
- Relative humidity: $5 \dots 95\%$ without condensation
- Ventilation by means of a fan is not required

